E-Box
Adjustment tool for wire bonders

Advantages during Production
- Better reproducibility of the adjustment depending attributes (e.g. loop forming) after change of wearing parts
- Longer life time of wearing parts

Advantages for Bond Process
- System for reproducible set-up of wedge, cutter and wire guide
- Camera system for optical visualisation of wedge, cutter and wire guide
- Set-up without microscope
- Free programmable, specified positions for bondhead elements
  - shown as limitation line
  - different views selectable (different sides, bottom, front etc.)
- Minimizes time expenditure for set-up work, set-up control and readjustment
- Process secured adjustment of wire feed elements (wedge, wire clamp, wire guide, cutter etc.)
- Graphical supported, visual control of:
  - wedge and wire guide position
  - distance between wedge and wire clamp
  - gap of wire clamp (fine wire)
  - wire pass
  - cutter respectively cutting position (heavy wire)

E-Box for wire bonders

The E-Box of the Hesse GmbH is a patent-registered visualisation system for control supported, reproducible adjustments of bondhead elements. It includes a camera for optical displaying of wedge, cutter and wire guide as well as a graphical support for adjustment- and positioning control. E-Box allows significant time reduction for setting up the machine.
Hesse GmbH - Your partner for ultrasonic and thermosonic wire bonders for all common wire dimensions as well as ultrasonic flipchip bonders in combination with standardized or customized automation solutions.

**E-Box**

Adjustment tool for wire bonders

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**E-Box BJ820**

**E-Box BJ855:** graphical ball inspection for ball-wedge

**E-Box screen BJ935/939**

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**E-Box version for BJ820**

**E-Box version for BJ855 with optional bondforce calibration**

**E-Box version for BJ935/939**

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Worldwide. Near you.